

PS7241-2B

# 8-PIN SOP, 400 V BREAK DOWN VOLTAGE NORMALLY CLOSE TYPE 2-ch Optical Coupled MOS FET

#### **DESCRIPTION**

The PS7241-2B is a solid state relay containing GaAs LEDs on the light emitting side (input side) and normally close (N.C.) contact MOS FETs on the output side.

It is suitable for analog signal control because of their low offset and high linearity.

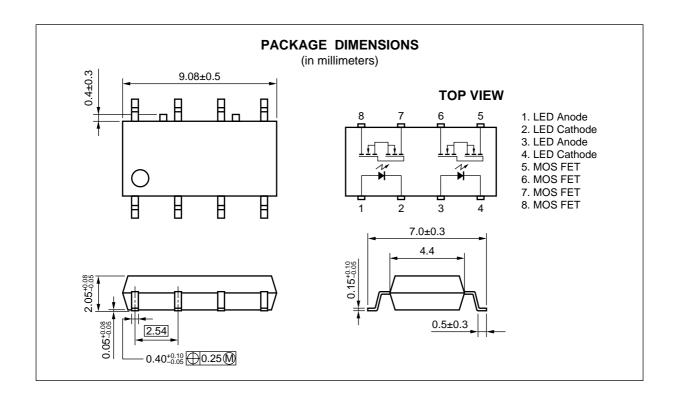
#### **FEATURES**

- 2 channel type (1 b + 1 b output)
- Low LED operating current (IF = 2 mA)
- · Designed for AC/DC switching line changer
- Small and thin package (8-pin SOP, Height = 2.1 mm)
- · Low offset voltage
- Ordering number of taping product: PS7241-2B-F3, F4
- UL approved: File No. E72422 (S)
- BSI approved: No. 8241/8242
- CSA approved: No. CA 101391

#### **APPLICATIONS**

- · Exchange equipment
- · Measurement equipment
- FA/OA equipment

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.



# **ORDERING INFORMATION (Solder Contains Lead)**

Part Number	Package	Packing Style	Application Part Number*1
PS7241-2B	8-pin SOP	Magazine case 45 pcs	PS7241-2B
PS7241-2B -F3		Embossed Tape 1 500 pcs/reel	
PS7241-2B -F4			

<sup>\*1</sup> For the application of the Safety Standard, following part number should be used.

# **ORDERING INFORMATION (Pb-Free)**

Part Number	Package	Packing Style	Application Part Number*1
PS7241-2B-A	8-pin SOP	Magazine case 45 pcs	PS7241-2B
PS7241-2B -F3-A		Embossed Tape 1 500 pcs/reel	
PS7241-2B -F4-A			

<sup>\*1</sup> For the application of the Safety Standard, following part number should be used.

# ABSOLUTE MAXIMUM RATINGS (TA = 25 °C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit	
Diode	Forward Current (DC)	lF	50	mA	
	Reverse Voltage	VR	5	V	
	Power Dissipation	Po	50	mW/ch	
	Peak Forward Current *1	IFP	1	Α	
MOS FET	Break Down Voltage	VL	400	٧	
	Continuous Load Current	lι	120	mA	
	Pulse Load Current <sup>*2</sup> (AC/DC Connection)	ILP	200	mA	
	Power Dissipation	Po	180	mW/ch	
Isolation Voltage *3		BV	1 500	Vr.m.s.	
Total Power Dissipation		Рт	460	mW	
Operating Ambient Temperature		TA	-40 to +85	°C	
Storage Temperature		T <sub>stg</sub>	-40 to +100	°C	

<sup>\*1</sup> PW = 100 μs, Duty Cycle = 1 %

<sup>\*2</sup> PW = 100 ms, 1 shot

<sup>\*3</sup> AC voltage for 1 minute at  $T_A = 25$  °C, RH = 60 % between input and output

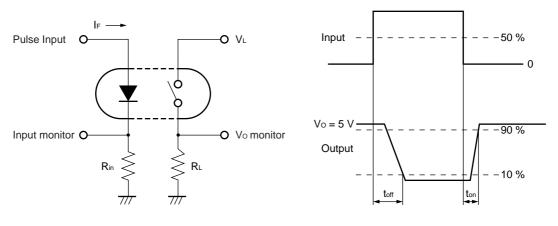
# RECOMMENDED OPERATING CONDITIONS (TA = 25 °C)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
LED Operating Current	lF	2	10	20	mA
LED Off Voltage	VF	0		0.5	V

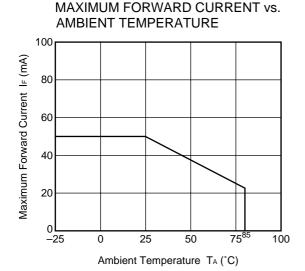
# ELECTRICAL CHARACTERISTICS (TA = 25 °C)

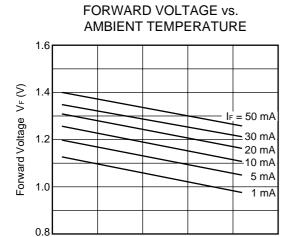
	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	IF = 10 mA		1.2	1.4	V
	Reverse Current	IR	V <sub>R</sub> = 5 V			5	μΑ
MOS FET	Off-state Leakage Current	Loff	I <sub>F</sub> = 10 mA, V <sub>D</sub> = 400 V		0.03	1.0	μА
	Output Capacitance	Cout	IF = 10 mA, VD = 0 V, f = 1.0 MHz		185		pF/ch
Coupled	LED Off-state Current	<b>I</b> Foff	IL = 120 mA			2.0	mA
	On-state Resistance	R <sub>on1</sub>	IF = 0 mA, IL = 10 mA		21	30	Ω
		R <sub>on2</sub>	$I_F = 0 \text{ mA}, I_L = 120 \text{ mA}, t \le 10 \text{ ms}$		16	25	
	Turn-on Time *1	ton	If = 10 mA, Vo = 5 V, $R_L$ = 500 $\Omega$ ,		0.02	0.2	ms
	Turn-off Time *1	toff	PW ≥ 10 ms		0.1	1.0	
	Isolation Resistance	Rı-o	Vi-o = 1.0 kVpc	10 <sup>9</sup>			Ω
	Isolation Capacitance	C <sub>I-O</sub>	V = 0 V, f = 1.0 MHz		0.4		pF/ch

# \*1 Test Circuit for Switching Time



# **★ TYPICAL CHARACTERISTICS (TA = 25 °C, unless otherwise specified)**





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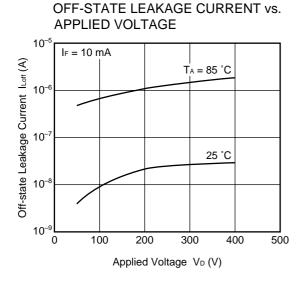
Ambient Temperature TA (°C)

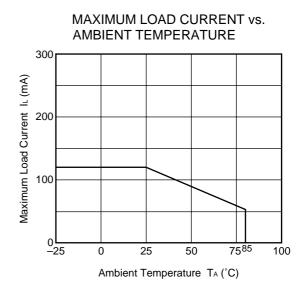
50

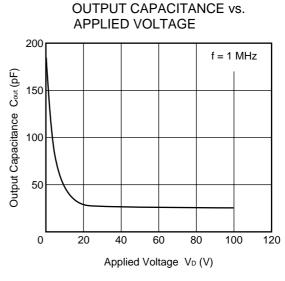
100

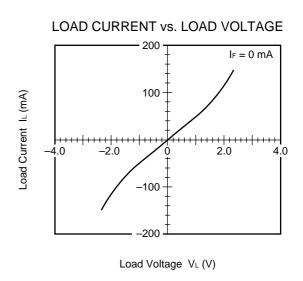
0

-25

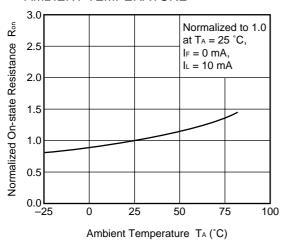




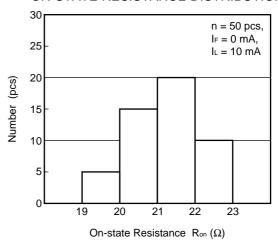




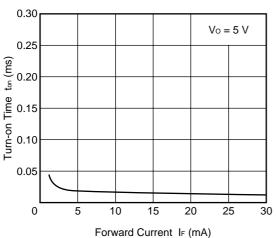
# NORMALIZED ON-STATE RESISTANCE vs. AMBIENT TEMPERATURE



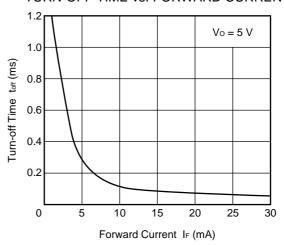
#### ON-STATE RESISTANCE DISTRIBUTION



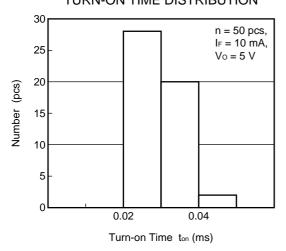
#### TURN-ON TIME vs. FORWARD CURRENT



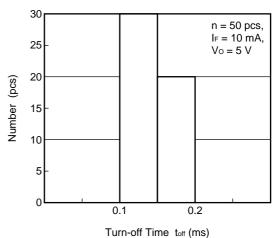
#### TURN-OFF TIME vs. FORWARD CURRENT



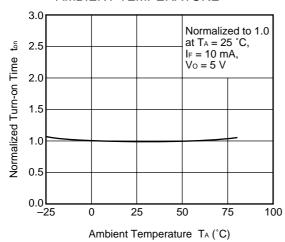
# TURN-ON TIME DISTRIBUTION



# TURN-OFF TIME DISTRIBUTION

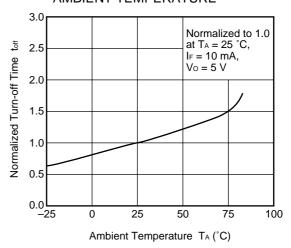


# NORMALIZED TURN-ON TIME vs. AMBIENT TEMPERATURE

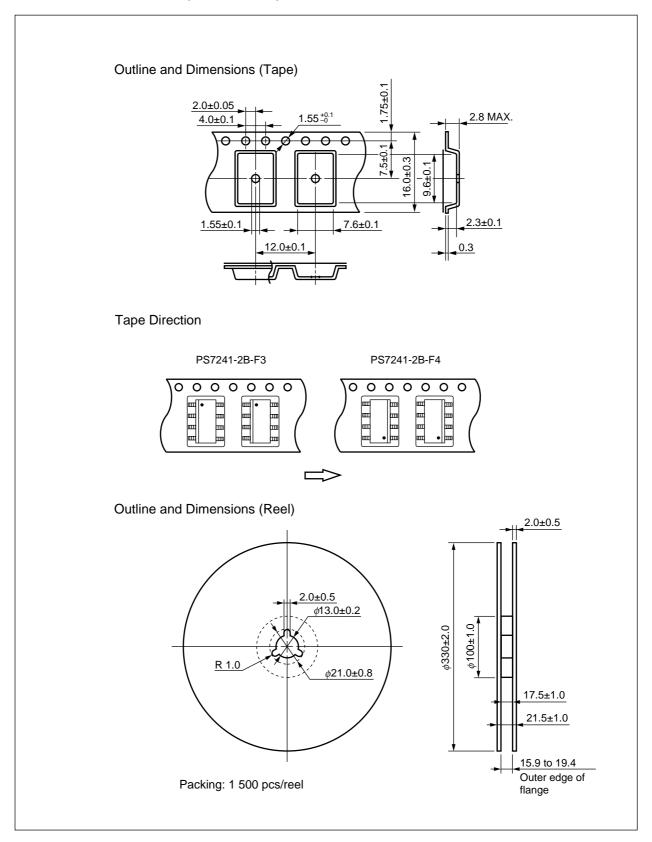


**Remark** The graphs indicate nominal characteristics.

# NORMALIZED TURN-OFF TIME vs. AMBIENT TEMPERATURE



# **★ TAPING SPECIFICATIONS (in millimeters)**



#### RECOMMENDED SOLDERING CONDITIONS

#### (1) Infrared reflow soldering

• Peak reflow temperature 260°C or below (package surface temperature)

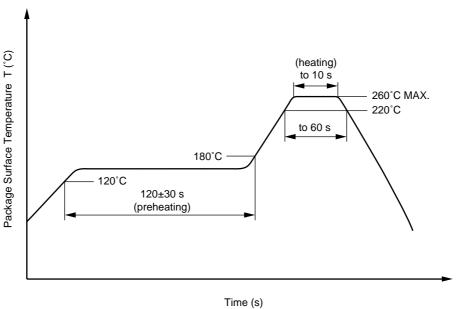
• Time of peak reflow temperature 10 seconds or less • Time of temperature higher than 220°C 60 seconds or less

• Time to preheat temperature from 120 to 180°C 120±30 s Number of reflows Three

• Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

### Recommended Temperature Profile of Infrared Reflow



### (2) Wave soldering

• Temperature 260°C or below (molten solder temperature)

• Time 10 seconds or less

· Preheating conditions 120°C or below (package surface temperature)

· Number of times

• Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine

content of 0.2 Wt% is recommended.)

#### (3) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.



4590 Patrick Henry Drive Santa Clara, CA 95054-1817 Telephone: (408) 919-2500

Facsimile: (408) 988-0279

Subject: Compliance with EU Directives

CEL certifies, to its knowledge, that semiconductor and laser products detailed below are compliant with the requirements of European Union (EU) Directive 2002/95/EC Restriction on Use of Hazardous Substances in electrical and electronic equipment (RoHS) and the requirements of EU Directive 2003/11/EC Restriction on Penta and Octa BDE.

CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The -AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (\*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)		on contained devices	
Lead (Pb)	< 1000 PPM	-A Not Detected	-AZ (*)	
Mercury	< 1000 PPM	Not Detected		
Cadmium	< 100 PPM	Not Detected		
Hexavalent Chromium	< 1000 PPM	Not Detected		
PBB	< 1000 PPM	Not Detected		
PBDE	< 1000 PPM	Not Detected		

If you should have any additional questions regarding our devices and compliance to environmental standards, please do not hesitate to contact your local representative.

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